

New Product

SUP33N20-60P

Vishay Siliconix

N-Channel 200-V (D-S) MOSFET

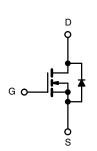
PRODUCT SUMMARY				
V _{(BR)DSS} (V)	r _{DS(on)} (Ω)	I _D (A)	Q _g (Тур)	
200	0.059 at V _{GS} = 15 V	33	53	
	0.060 at V _{GS} = 10 V	33	- 55	

FEATURES

- TrenchFET[®] Power MOSFETS
- 175 °C Junction Temperature
- 100 % UIS and $\rm R_g$ Tested

APPLICATIONS

- Power Supply
- Lighting
- Industrial



TO-220AB

Top View

Ordering Information: SUP33N20-60P-E3 (Lead (Pb)-free)

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _C = 25 °C, unless ot	herwise noted			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	200	v	
Gate-Source Voltage		V _{GS}	± 25	v	
Continuous Drain Current (T_{1} = 175 °C)	T _C = 25 °C	1-	33		
Continuous Drain Current (1j = 175 C)	T _C = 100 °C		20.8	•	
Pulsed Drain Current		I _{DM}	80	A	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	20		
Single Pulse Avalanche Energy ^a	L = 0.1 mm	E _{AS}	20	mJ	
Maximum Power Dissipation ^a	T _C = 25 °C	В	156 ^b	14/	
	T _A = 25 °C ^c	- P _D -	3.12	- w	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Limit	Unit	
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	40	°C/W	
Junction-to-Case (Drain)	R _{thJC}	0.8		

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When Mounted on 1" square PCB (FR-4 material).



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Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Static	- 			·		
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	200			v
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	2.5		4.5	
Gate-Body Leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V			± 100	- nA
Gale-Body Leakage		V_{DS} = 0 V, V_{GS} = ± 25 V			± 300	
Zero Gate Voltage Drain Current		$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
	I _{DSS}	V_{DS} = 200 V, V_{GS} = 0 V, T_{J} = 100 °C			25	
		V_{DS} = 200 V, V_{GS} = 0 V, T_{J} = 150 °C			250	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10$ V, $V_{GS} = 10$ V	40			Α
Drain-Source On-State Resistance ^a		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.049	0.060	- Ω
	r	$V_{GS} = 15 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.0485	0.059	
	r _{DS(on)}	V_{GS} = 10 V, I _D = 20 A, T _J = 100 °C			0.110	
		V_{GS} = 10 V, I _D = 20 A, T _J = 150 °C			0.144	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A	25			S
Dynamic ^b	+			•		
Input Capacitance	C _{iss}			2735		pF
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz		271		
Reverse Transfer Capacitance	C _{rss}			117		
Tatal Cata Charge		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 15 \text{ V}, \text{ I}_{D} = 50 \text{ A}$		75	113	
Total Gate Charge ^c	Qg			53	80	nC
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 100 V, V_{GS} = 10 V, I_{D} = 50 A		14		
Gate-Drain Charge ^c	Q _{gd}			17.5		
Gate Resistance	R _g	f = 1 MHz		1.2	1.8	Ω
Turn-On Delay Time ^c	t _{d(on)}			16	25	ns
Rise Time ^c	t _r	V_{DD} = 100 V, R_L = 2 Ω		170	260	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 50$ Å, $V_{GEN} = 10$ V, $R_g = 1 \Omega$		26	40	
Fall Time ^c	t _f			9	18	
Source-Drain Diode Ratings and Cha	racteristics	(T _C = 25 °C) ^b				
Continuous Current	ا _S				33	A
Pulsed Current	I _{SM}				80	
Forward Voltage ^a	V _{SD}	I _F = 20 A, V _{GS} = 0 V		0.86	1.5	V
Reverse Recovery Time	t _{rr}			114	170	ns
Peak Reverse Recovery Current	I _{RM(REC)}			12	Α	
Reverse Recovery Charge	Q _{rr}	I _F = 40 A, di/dt = 100 A/µs		0.46	0.69	μC
Reverse Recovery Fall Time	t _a	82				
Reverse Recovery Rise Time	t _b			32		nS

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

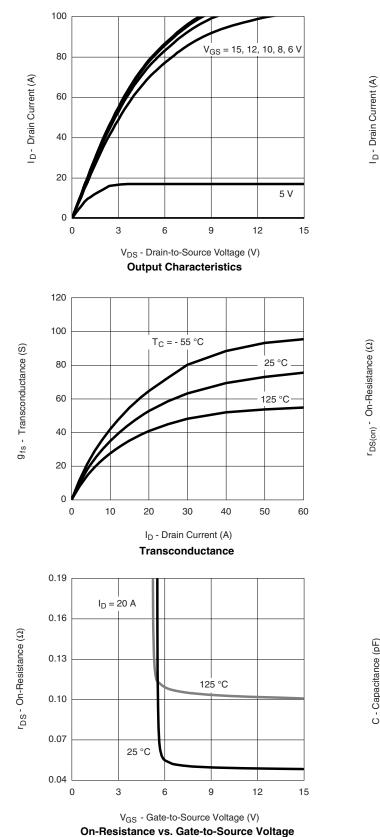
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

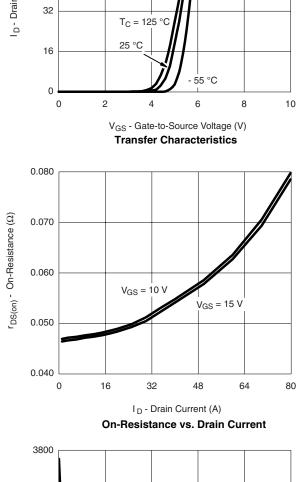


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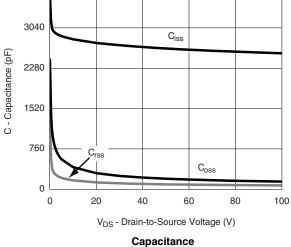
TYPICAL CHARACTERISTICS 25 °C, unless noted



80

64

48

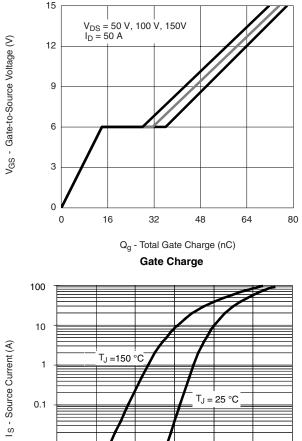


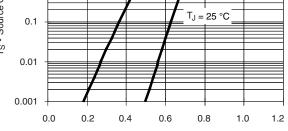
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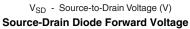
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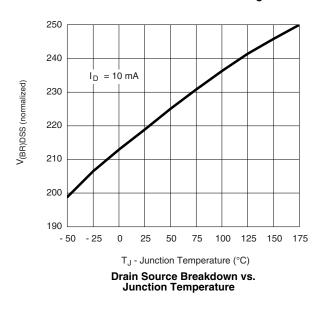
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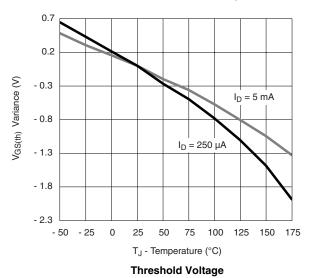


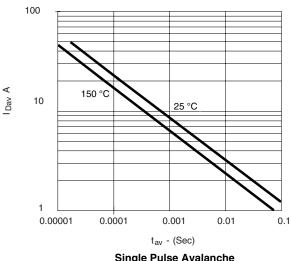


2.9 $I_D = 20$ Å 2.4 r_{DS(on)} - On-Resistance (Normalized) $V_{GS} = 10 V$ 1.9 V_{GS} = 15 V 1.4 0.9 0.4 - 25 25 150 175 - 50 0 50 75 100 125 T_J - Junction Temperature (°C)

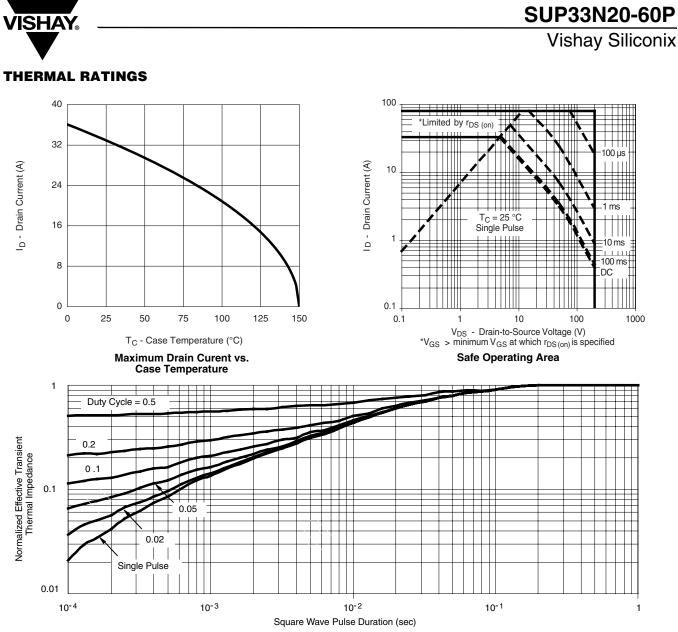
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On-Resistance vs. Junction Temperature





Single Pulse Avalanche Current Capability vs. Time



Normalized Thermal Transient Impedance, Junction-to-Case

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